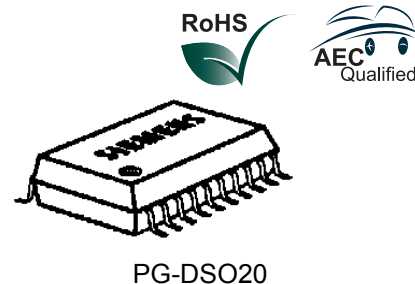


The device allows continuous power control for lamps, LEDs or inductive loads.

- Highside switch (Bootstrap)
- Overtemperature protection
- Short circuit / overload protection through pulse width reduction and overload shutdown
- Load dump protection
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis
- Reverse battery protection ¹⁾
- Timing frequency adjustable
- Controlled switching rise and fall times
- Maximum current internally limited
- Protection against loss of GND ²⁾
- Electrostatic discharge (ESD) protection
- Package: P-DSO-20-6 (SMD)



Note: Switching frequency is programmed with an external capacitor

- RoHS compliant (green product)
- AEC qualified

Maximum Ratings

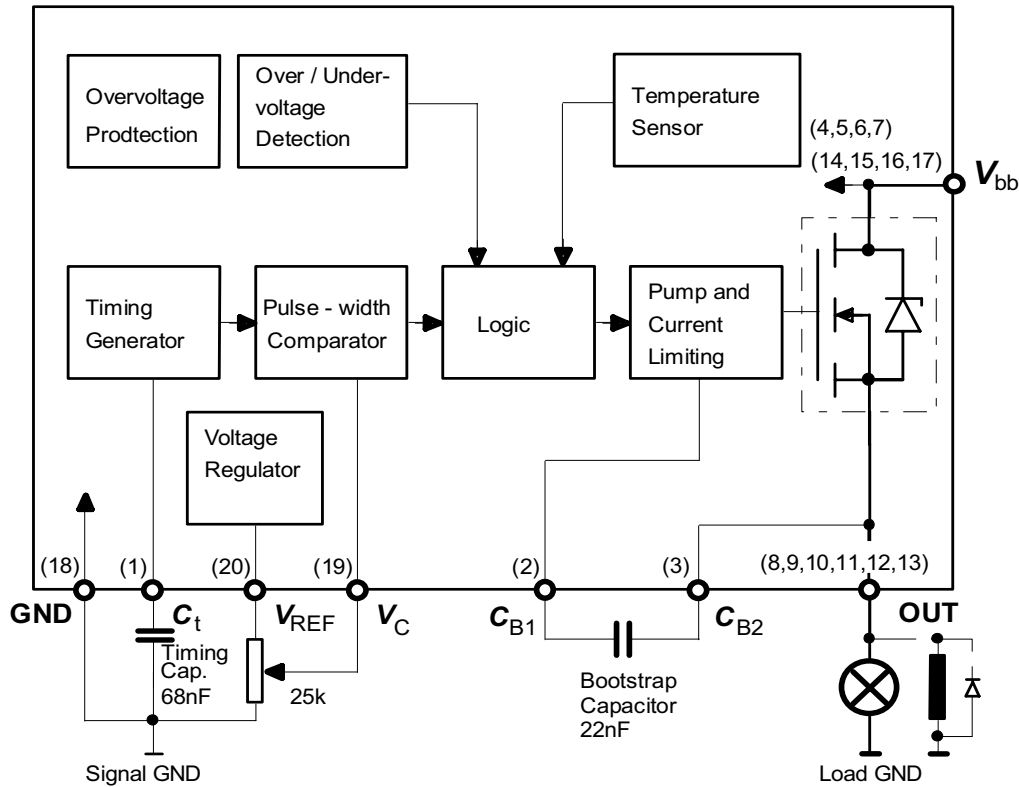
Parameter	Symbol	Values	Unit
Active overvoltage protection	$V_{bb(AZ)}$	>40	V
Short circuit current	I_{SC}	self-limited	-
Input current (DC)	I_{Ct}	2	mA
Pin1 (C_t) and pin19 (V_C)	I_{VC}	2	mA
Operating temperature range	T_j	-40...+150	°C
Storage temperature range	T_{stg}	-50...+150	
Power dissipation ³⁾ $T_a=25^{\circ}C$	P_{tot}	3	W
$T_a=85^{\circ}C$		2	W
Thermal resistance chip-case ³⁾	$R_{th JC}$	≤35	K/W
chip-ambient	$R_{th JA}$	≤75	
Electrostatic discharge capability (ESD) (Human Body Model) acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993; R=1.5KΩ; C=100pF	V_{ESD}	≤ 1	kV

¹⁾ With 150Ω resistor in signal GND connection.

²⁾ Potential between signal GND and load GND >0.5V

³⁾ Device on 50mm×50mm×1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70μm thick) copper area for V_{bb} connection, PCB is vertical without air blowing.

Block Diagram



Pin Definitions and Funktionen

Pin	Symbol	Funktionen
1	C_t	Timing capacitor for frequency
2	C_{B1}	Bootstrap capacitor
3	C_{B2}	
4,5,6,7	V_{bb}	Supply voltage (Leadframe connected)
14,15,16,17		
8,9,10	OUT	Output
11,12,13		
18	GND	Ground
19	V_C	Voltage for PWM-Control
20	V_{REF}	Reference Voltage

Pin Configuration (top view)

C_t	1	20	V_{REF}
C_{B1}	2	19	V_C
C_{B2}	3	18	GND
V_{bb}	4	17	V_{bb}
V_{bb}	5	16	V_{bb}
V_{bb}	6	15	V_{bb}
V_{bb}	7	14	V_{bb}
OUT	8	13	OUT
OUT	9	12	OUT
OUT	10	11	OUT

Electrical Characteristics

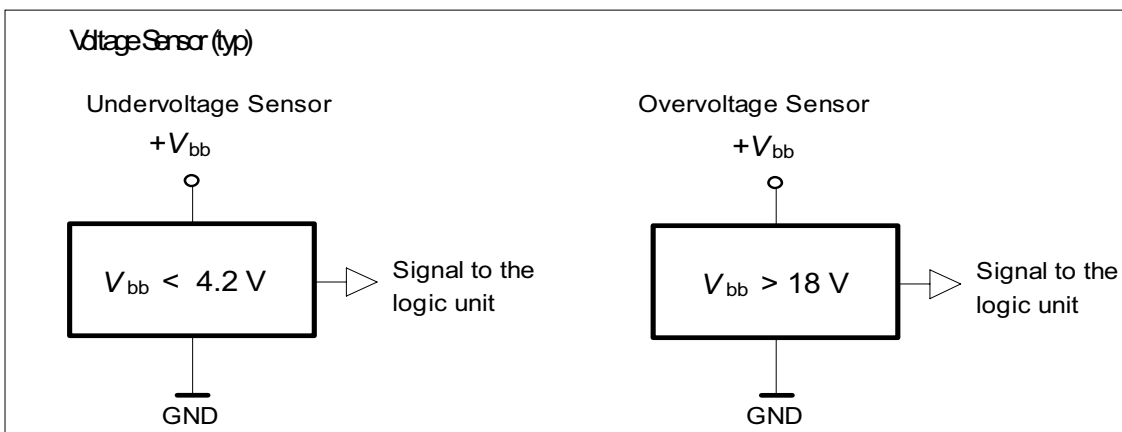
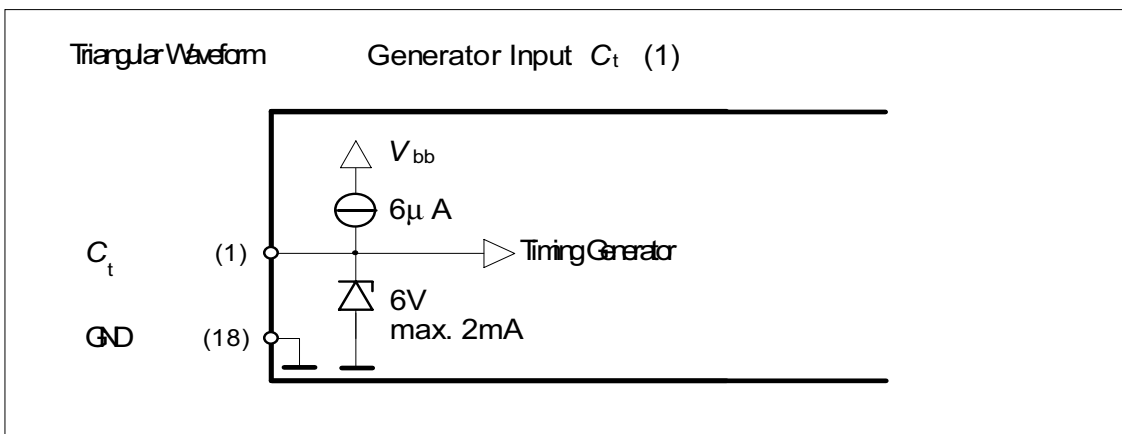
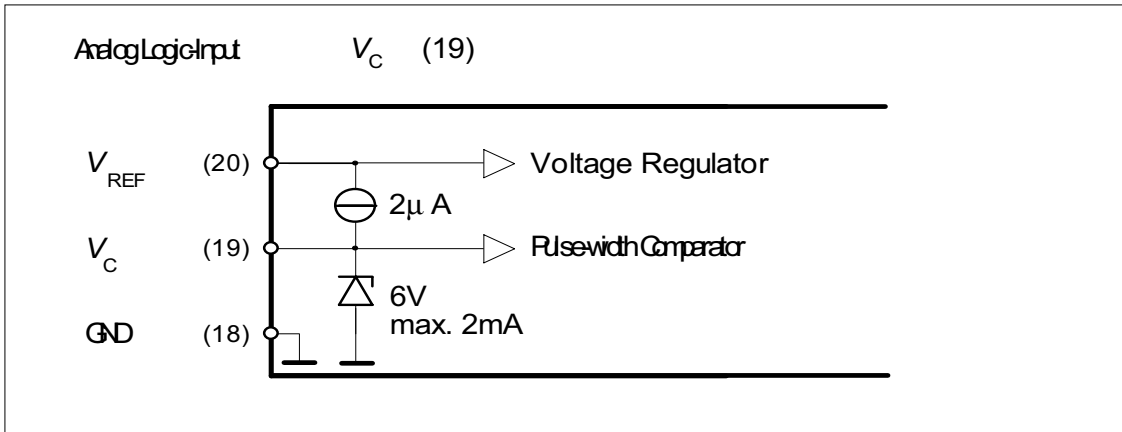
at $T_C = 25^\circ\text{C}$, $V_{bb} = 12\text{ V}$, unless otherwise specified. $C_{\text{Bootstrap}} = 22\text{ nF}$

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
On-state resistance $I_L = 3\text{ A}$, $V_{bb} = 12\text{ V}$	R_{ON}	-	-	70	m Ω
Operating voltage $T_C = -40 \dots +150^\circ\text{C}$	V_{bb}	5.9 ¹⁾	-	16.9 ²⁾	V
Nominal current, calculated value ISO-standard: $V_{bb} - V_{\text{OUT}} \leq 0.5\text{ V}$, $T_C = 85^\circ\text{C}$	$I_L\text{-ISO}$	3	-	-	A
Load current limit $V_{bb} - V_{\text{OUT}} > 1\text{ V}$, $T_C = -40 \dots +150^\circ\text{C}$	I_{LLim}	-	20	-	A
Undervoltage shutdown $I_L = 3\text{ A}$, $T_C = -40 \dots +150^\circ\text{C}$	$V_{bb(\text{LOW})}$	3	4.2	5.4	V
Overvoltage shutdown $I_L = 3\text{ A}$, $T_C = -40 \dots +150^\circ\text{C}$	$V_{bb(\text{HI})}$	17	18	19	V
Max. output voltage (RMS) $I_L = 3\text{ A}$, $V_{bb} > 12\text{ V}$ $T_C = -40 \dots +150^\circ\text{C}$	V_{RMSmax}	12	-	14	V
Reference voltage $I_{\text{REF}} = 10\text{ mA}$, $T_C = -40 \dots +150^\circ\text{C}$	V_{REF}	2		3	V
Reference current pin 18 (GND) to pin 20 (V_{REF}) short	I_{REF}	-	150	-	mA
Internal current consumption during operation, measured in PWM gap $T_C = -40 \dots +150^\circ\text{C}$	I_R	-		5	mA
Bootstrap voltage, pin 2 (C_{B1}) to pin 3 (C_{B2}) $V_{bb} = 12\text{ V}$, $T_C = -40 \dots +150^\circ\text{C}$	V_B	-	10	-	V
PWM frequency $T_C = -40 \dots +150^\circ\text{C}$, $C_t = 68\text{ nF}$	f_{PWM}	50	-	100	Hz
Max. pulse duty factor $I_L = 3\text{ A}$, $V_C = 0\text{ V}$, (50% V_{OUT})	D_{imax}	95	98	-	%
Min. pulse duty factor $I_L = 3\text{ A}$, $V_C = 0\text{ V}$, (50% V_{OUT})	D_{imin}	3	8	14	%
Slew rate "on" 10 ... 90% I_{OUT}	$du/dt_{(\text{on})}$	20	-	120	mV/ μs
Slew rate "off" 90 ... 10% I_{OUT}	$du/dt_{(\text{off})}$	20	-	120	mV/ μs
Thermal overload trip temperature	T_j	150	-	-	$^\circ\text{C}$

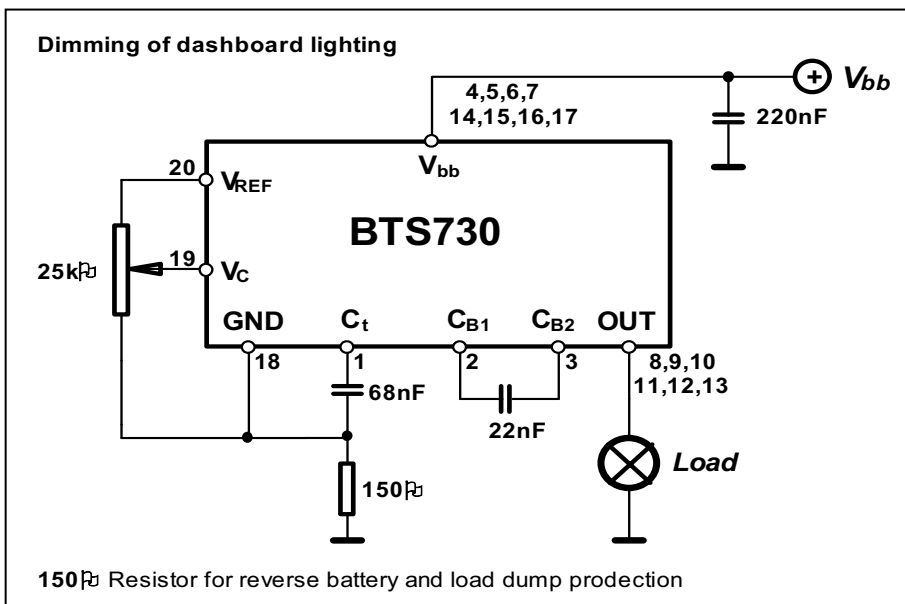
¹⁾ **Note:** undervoltage shutdown

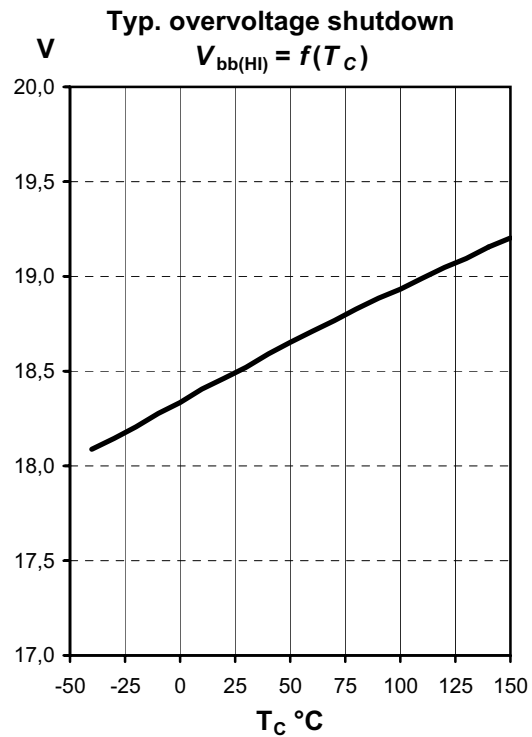
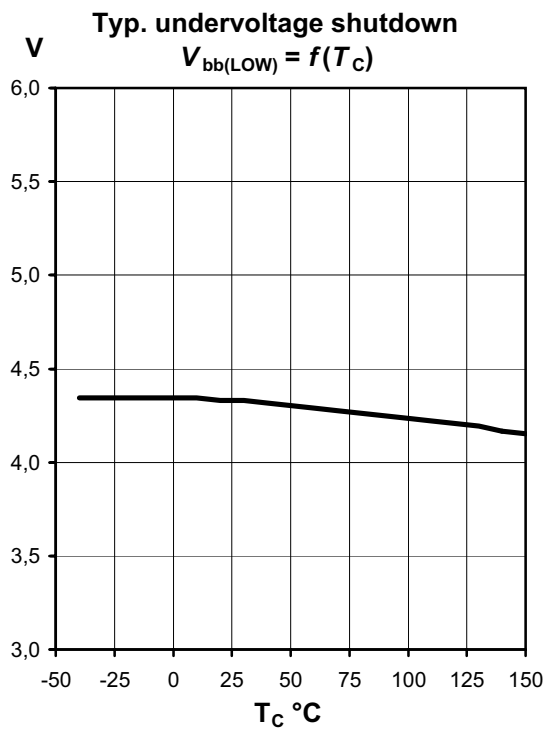
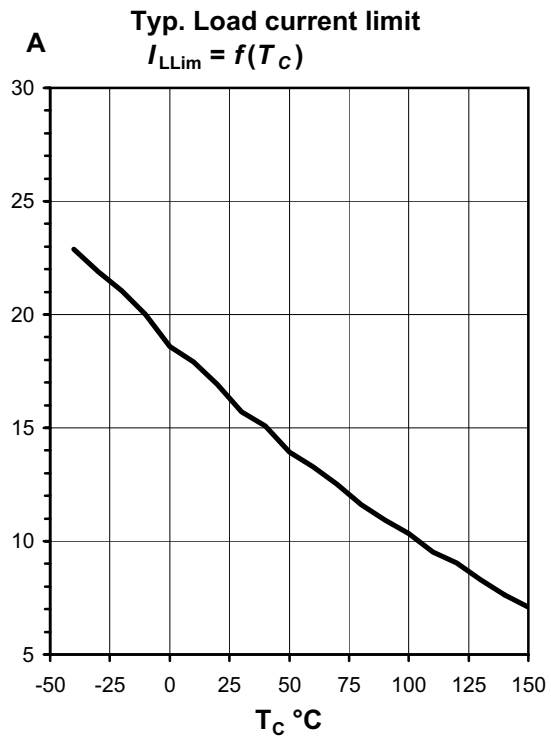
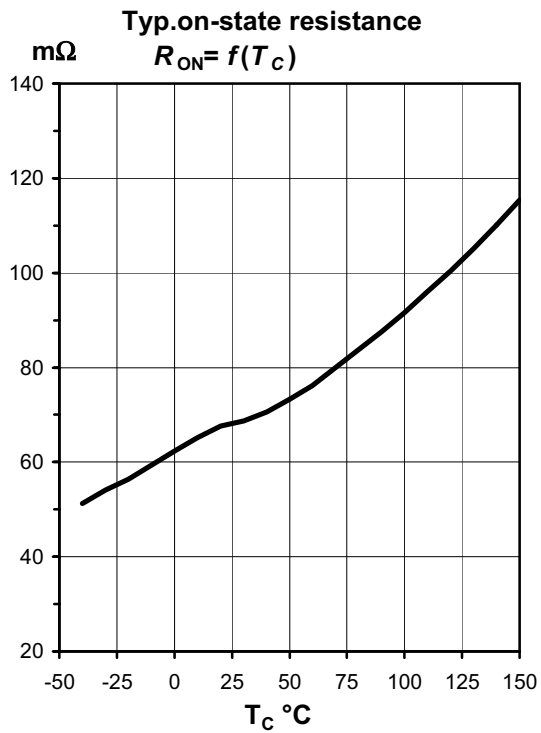
²⁾ **Note:** overvoltage shutdown

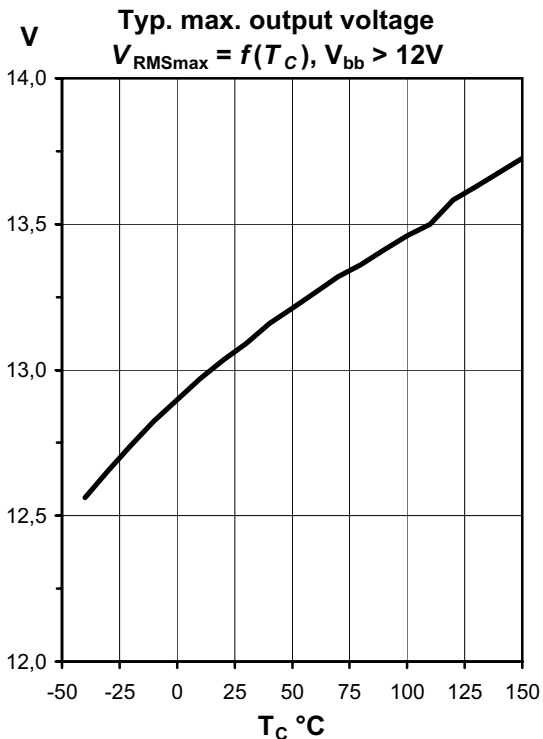
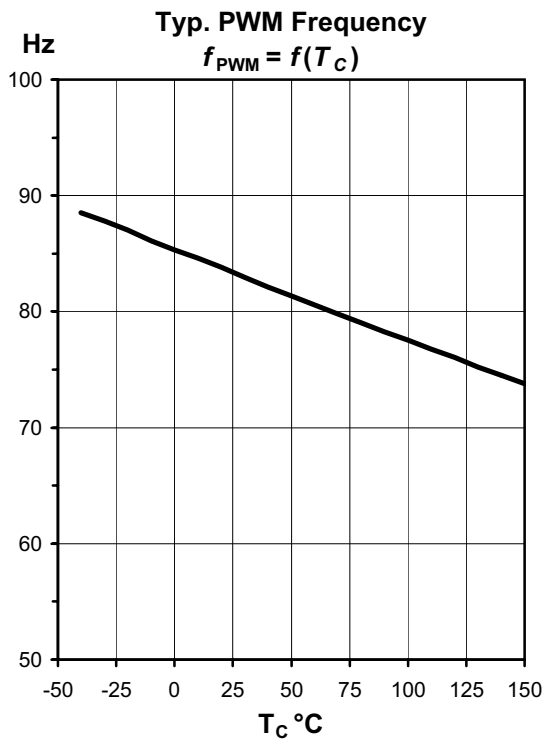
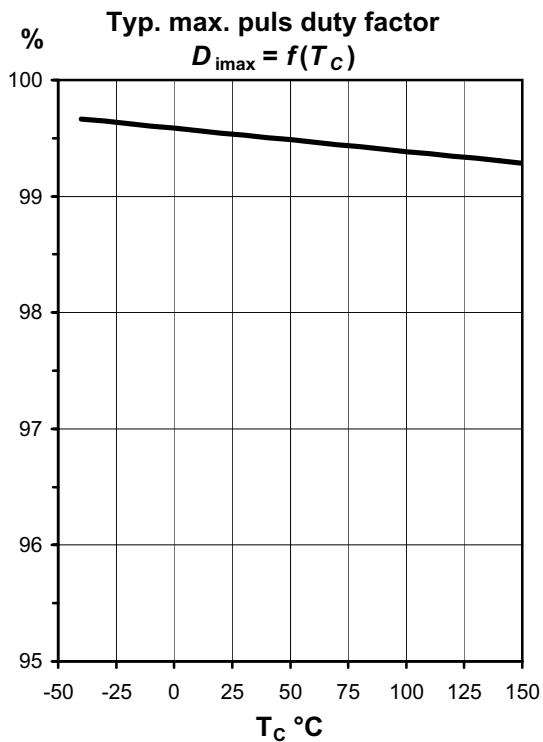
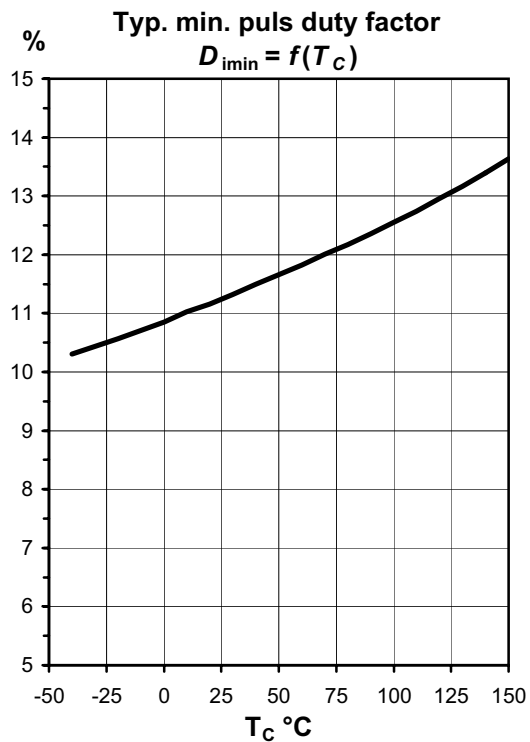
Circuits



Application Note







Package Outlines

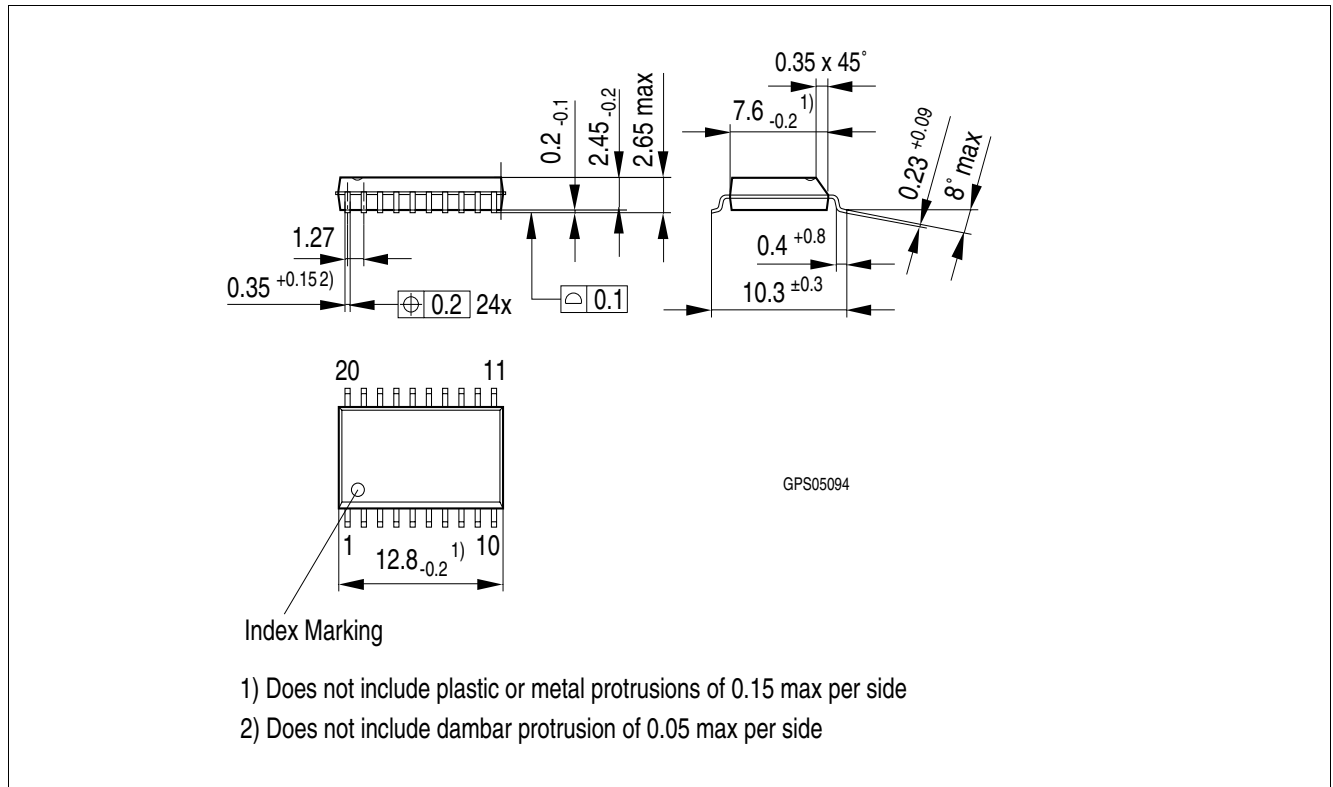


Figure 1 PG-DSO-20 (Plastic Dual Small Outline Package) (RoHS-compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

Revision History

Version	Date	Changes
V1.0	2007-12-17	Creation of the green datasheet. First page : Adding the green logo and the AEC qualified Adding the bullet AEC qualified and the RoHS compliant features Package page Modification of the package to be green.

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